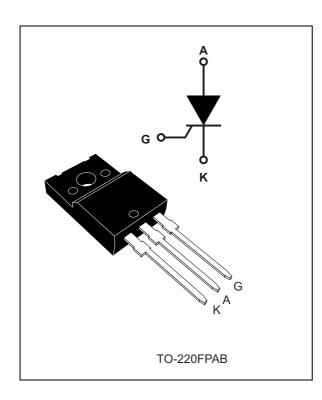
## TN2015H-6FP



### High temperature 20 A SCRs

Datasheet - production data



#### **Features**

- High junction temperature: T<sub>i</sub> = 150 °C
- High noise immunity dV/dt = 750 V/μs up to 150 °C
- Gate triggering current I<sub>GT</sub> = 15 mA
- Blocking voltage V<sub>DRM</sub>/V<sub>RRM</sub> = 600 V
- High turn on current rise dl/dt: 100 A/µs
- ECOPACK<sup>®</sup>2 compliant component
- Complies with UL standards (File ref: E81734)
- Insulated package TO-220FPAB:
  - Insulated voltage: 2000 VRMS

### **Applications**

- · Voltage regulator circuits for motorbikes
- · Inrush current limiting circuits
- Motor control circuits and starters
- Light dimmers
- Solid state relays

#### **Description**

Thanks to a junction temperature  $T_j$  up to 150 °C and an insulated TO-220FPAB package, the TN2015H-6FP offers high thermal performance operation up to 20 A rms.

The trade-off between the device's noise immunity (dV/dt = 750 V/ $\mu$ s), its gate triggering current (I<sub>GT</sub> = 15 mA) and its turn-on current rise (dl/dt = 100 A/ $\mu$ s) allows the design of robust and compact control circuits for voltage regulators in motorbikes and industrial drives, overvoltage crowbar protection, motor control circuits in power tools and kitchen aids, inrush current limiting circuits.

The insulated fullpack package allows a back-to-back configuration.

Table 1. Device summary

Order code	Package	V <sub>DRM</sub> /V <sub>RRM</sub>	I <sub>GT</sub>
TN2015H-6FP	TO-220FPAB	600 V	15 mA

Characteristics TN2015H-6FP

## 1 Characteristics

Table 2. Absolute ratings

Symbol	Paramete	Value	Unit			
I <sub>T(RMS)</sub>	On-state rms current (180° conduction a	20	Α			
			T <sub>c</sub> = 80 °C	12.7		
I <sub>T(AV)</sub>	Average on-state current (180° conduction angle)		T <sub>c</sub> = 99 °C	10	Α	
			T <sub>c</sub> = 112 °C	8		
1 .	Non repetitive surge peak on-state curre	ent	t = 8.3 ms	197	Α	
I <sub>TSM</sub>	$(T_j initial = 25 °C)$		t = 10 ms	180	A	
l <sup>2</sup> t	I <sup>2</sup> t value for fusing (T <sub>j</sub> initial = 25 °C)	$t_p = 10 \text{ ms}$	162	A²s		
dl/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \le 100$ ns, $T_i = 25$ °C		F = 60 Hz	100	A/µs	
V <sub>DRM</sub> , V <sub>RRM</sub>	Repetitive peak off-state voltage			600	٧	
$I_{GM}$	Peak gate current	t <sub>p</sub> = 20 μs	T <sub>j</sub> = 150 °C	4	Α	
P <sub>G(AV)</sub>	Average gate power dissipation $T_j = 150$		T <sub>j</sub> = 150 °C	1	W	
T <sub>stg</sub> T <sub>j</sub>	Storage junction temperature range Operating junction temperature range		- 40 to + 150 - 40 to + 150	°C		
$T_L$	Maximum lead temperature for soldering during 10 s			260	°C	
V <sub>ins</sub>	Insulation rms voltage, 1 minute TO-220FPAB			2000	V	

Table 3. Electrical characteristics ( $T_j = 25$  °C, unless otherwise specified)

Symbol	Test conditions			Value	Unit
1	$V_D = 12 \text{ V}, R_L = 33 \Omega$		Тур.	6	mA
I <sub>GT</sub>			Max.	Max.	15
$V_{GT}$	$V_D = 12 \text{ V}, R_L = 33 \Omega$		Max.	1.3	V
$V_{GD}$	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$ $T_j = 150 ^{\circ}\text{C}$		Min.	0.2	V
I <sub>H</sub>	I <sub>T</sub> = 500 mA, gate open		Max.	50	mA
IL	$I_{G} = 1.2 \times I_{GT}$		Max.	60	mA
dV/dt	$V_D = 402 \text{ V, gate open}$ $T_j = 150 ^{\circ}\text{C}$		Min.	750	V/µs
t <sub>gt</sub>	$I_T = 40 \text{ A}, V_D = 600 \text{ V}, I_G = 100 \text{ mA},$ $(dI_G/dt) \text{max} = 0.2 \text{ A/}\mu\text{s}$		Тур	1.9	μs
t <sub>q</sub>	$V_D = 402 \text{ V}, V_R = 25 \text{ V}, I_T = 20 \text{ A}, \\ (dI_G/dt) max = 30 \text{ A/}\mu\text{s}, dV_D/dt = 50 \text{ V/}\mu\text{s} $ $T_j = 150 ^{\circ}\text{C}$		Тур	70	μs

TN2015H-6FP Characteristics

**Table 4. Static characteristics** 

Symbol	Test conditions			Value	Unit
$V_{TM}$	$I_{TM} = 40 \text{ A}, t_p = 380  \mu\text{s}$	T <sub>j</sub> = 25 °C	Max.	1.6	V
V <sub>t0</sub>	Threshold voltage	T <sub>j</sub> = 150 °C	Max.	0.82	V
R <sub>d</sub>	Dynamic resistance	T <sub>j</sub> = 150 °C	Max.	17.5	mΩ
I <sub>DRM,</sub>	V - V - V	T <sub>j</sub> = 25 °C	Max.	5	μΑ
I <sub>RRM</sub>	$V_D = V_{DRM}, V_R = V_{RRM}$	T <sub>j</sub> = 150 °C	iviax.	2	mA

Table 5. Thermal resistance

Symbol	Parameter		Unit
R <sub>th(j-c)</sub>	Junction to case (AC)	4.0	°C/W
$R_{th(j-a)}$	Junction to ambient (DC)	60	°C/W

Figure 1. Maximum power dissipation versus average on-state current

20 P(W) α = 180°. DC. 18 α = 120° α = 90° 16 14  $\alpha = 30$ 12 10 8 6 4 2  $I_{T(AV)}(A)$ 15 10

Figure 2. Average and DC on-state current versus case temperature

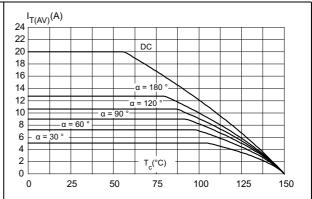
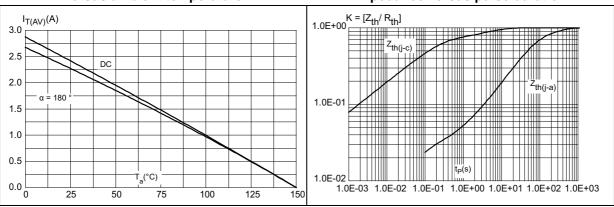


Figure 3. Average and DC on-state current versus ambient temperature

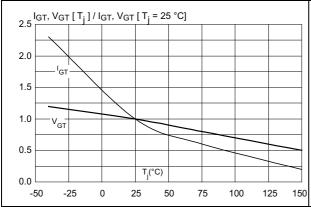
Figure 4. Relative variation of thermal impedance versus pulse duration



Characteristics TN2015H-6FP

Figure 5. Relative variation of gate triggering current and gate voltage versus junction temperature (typical values)

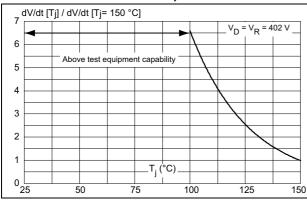
Figure 6. Relative variation of holding current and latching current versus junction temperature (typical values)



2.5 2.0 1.5 1.0 1.0 0.5 0.0 -50 -25 0 25 50 75 100 125 150

Figure 7. Relative variation of static dV/dt immunity versus junction temperature (typical values)

Figure 8. Surge peak on-state current versus number of cycles



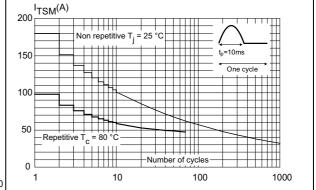
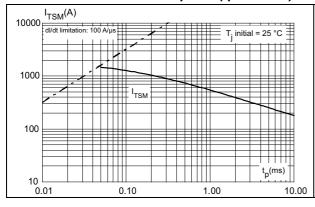
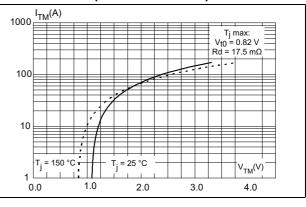


Figure 9. Non-repetitive surge peak on-state current for a sinusoidal pulse (tp < 10 ms)

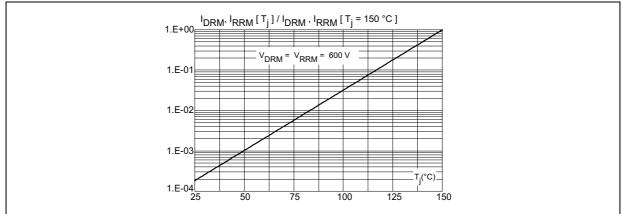
Figure 10. On-state characteristics (maximum values)





TN2015H-6FP Characteristics

Figure 11. Relative variation of leakage current versus junction temperature (tp < 10 ms)



**Package information** TN2015H-6FP

#### **Package information** 2

- Epoxy meets UL94, V0
- Lead-free package
- Halogen free molding compound
- Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK® is an ST trademark.

Н Dia L6 L2 L7 L3 L5 D F1 L4 F2 F G1 G

Figure 12. TO-220FPAB dimension definitions

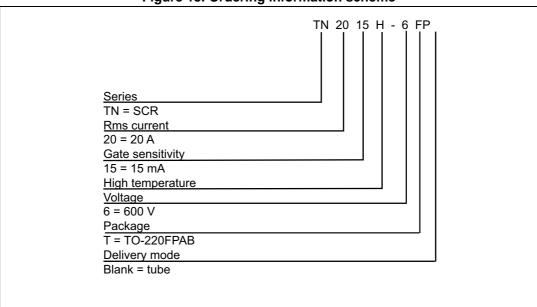
Table 6. TO-220FPAB dimensions

		nsions			
Ref.	Millimeters		Inc	hes	
	Min.	Max.	Min.	Max.	
А	4.4	4.6	0.173	0.181	
В	2.5	2.7	0.098	0.106	
D	2.5	2.75	0.098	0.108	
E	0.45	0.70	0.018	0.027	
F	0.75	1	0.030	0.039	
F1	1.15	1.70	0.045	0.067	
F2	1.15	1.70	0.045	0.067	
G	4.95	5.20	0.195	0.205	
G1	2.4	2.7	0.094	0.106	
Н	10	10.4	0.393	0.409	
L2	16 <sup>-</sup>	Тур.	0.63	Тур.	
L3	28.6	30.6	1.126	1.205	
L4	9.8	10.6	0.386	0.417	
L5	2.9	3.6	0.114	0.142	
L6	15.9	16.4	0.626	0.646	
L7	9.00	9.30	0.354	0.366	
Dia.	3.00	3.20	0.118	0.126	

Ordering information TN2015H-6FP

# 3 Ordering information

Figure 13. Ordering information scheme



**Table 7. Ordering information** 

Order code	Order code Marking		Weight	Base qty	Delivery mode
TN2015H-6FP	TN2015H6	TO-220FPAB	2.0 g	50	Tube

## 4 Revision history

Table 8. Document revision history

Date	Revision	Changes
25-Feb-2015	1	Initial release.

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